30V P-Channel PowerTrench[®] MOSFET

General Description

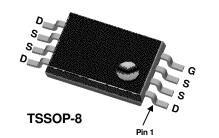
This P.Channel MOSFET is a rugged gate version of Fairchild Semiconductor's advanced PowerTrench process. It has been optimized for power management applications requiring a wide range of gave drive voltage ratings (4.5V - 25V).

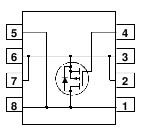
Applications

- Battery protection
- DC/DC conversion
- Power management
- Load switch

Features

- $\label{eq:BCON} \begin{array}{l} \bullet \ -8 \ A, \ -30 \ V \\ R_{DS(ON)} = 13.5 \ m\Omega \ @ \ V_{GS} = -10 \ V \\ R_{DS(ON)} = 20 \ m\Omega \ @ \ V_{GS} = -4.5 \ V \end{array}$
- Extended V_{GSS} range (±25V) for battery applications
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- Low profile TSSOP-8 package





Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Parameter			Ratings	Units		
V _{DSS}	Drain-Sourc	e Voltage		-30	V		
V _{GSS}	Gate-Source	e Voltage		± 25			
l _D	Drain Curre	nt – Continuous	(Note 1)	-8	Α		
	– Pulsed			-50			
PD	Power Dissipation (No		(Note 1a)	1.3	W		
			(Note 1b)	0.6			
	Operating and Storage Junction Temperature Range			-55 to +150			
T_J, T_{STG}	Operating a	nd Storage Junction T	emperature Range	-55 to +150	C°		
Therma	l Charact	0		-55 to +150 96			
.,	l Charact	eristics			°C WO°		
Therma Reja Packag	I Charact	eristics	Ambient (Note 1a) (Note 1b)	96			

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics	I				
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_D = -250 \mu A$	-30			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C		-23		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = -24 V, V_{GS} = 0 V$			-1	μA
GSSF	Gate-Body Leakage, Forward	$V_{GS} = 25 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			100	nA
GSSR	Gate-Body Leakage, Reverse	$V_{GS} = -25 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, \qquad I_D = -250 \ \mu A$	-1	-1.7	-3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu A$, Referenced to 25°C		5		mV/ºC
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{l} V_{GS} = -10 \ V, I_{D} = -8.0 \ A \\ V_{GS} = -4.5 \ V, I_{D} = -6.5 \ A \\ V_{GS} = -10 \ V, I_{D} = -8.0 \ A, \ T_{J} = 125^{\circ} C \end{array} $		11 16 15	13.5 20 19	mΩ
D(on)	On-State Drain Current	$V_{GS} = -10 V$, $V_{DS} = -5 V$	-50			Α
g _{FS}	Forward Transconductance	$V_{DS} = -5 V$, $I_D = -8.0 A$		30		S
Dvnamic	Characteristics					
Ciss	Input Capacitance	$V_{DS} = -15 V$, $V_{GS} = 0 V$,		2267		pF
Coss	Output Capacitance	f = 1.0 MHz		599		pF
Crss	Reverse Transfer Capacitance			315		pF
Switchin	g Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time	$V_{DD} = -15 V$, $I_D = -1 A$,		15	27	ns
tr	Turn–On Rise Time	$V_{GS} = -10 \text{ V}, R_{GEN} = 6 \Omega$		11	35	ns
t _{d(off)}	Turn–Off Delay Time			78	125	ns
t _f	Turn–Off Fall Time			45	72	ns
Qg	Total Gate Charge	$V_{DS} = -15 V$, $I_D = -8.0 A$,		28	38	nC
Q _{gs}	Gate–Source Charge	$V_{GS} = -5.0V$		7		nC
Q _{gd}	Gate–Drain Charge			12		nC
Drain-So	ource Diode Characteristics	and Maximum Ratings				
s	Maximum Continuous Drain-Source				-1.2	Α
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 \ V, I_S = -1.2 \ A (Note 2)$		-0.7	-1.2	V

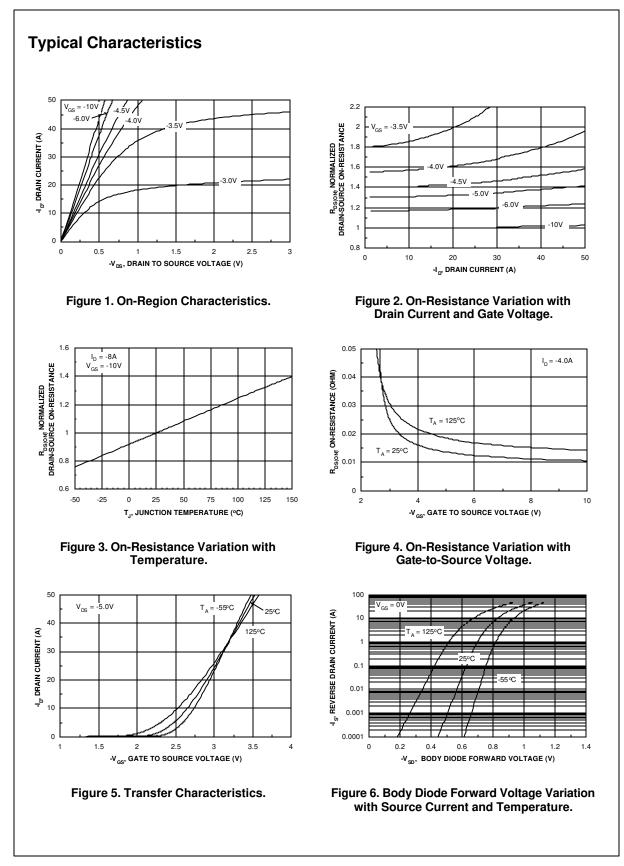
the drain pins. $\rm R_{6JC}$ is guaranteed by design while $\rm R_{6CA}$ is determined by the user's board design.

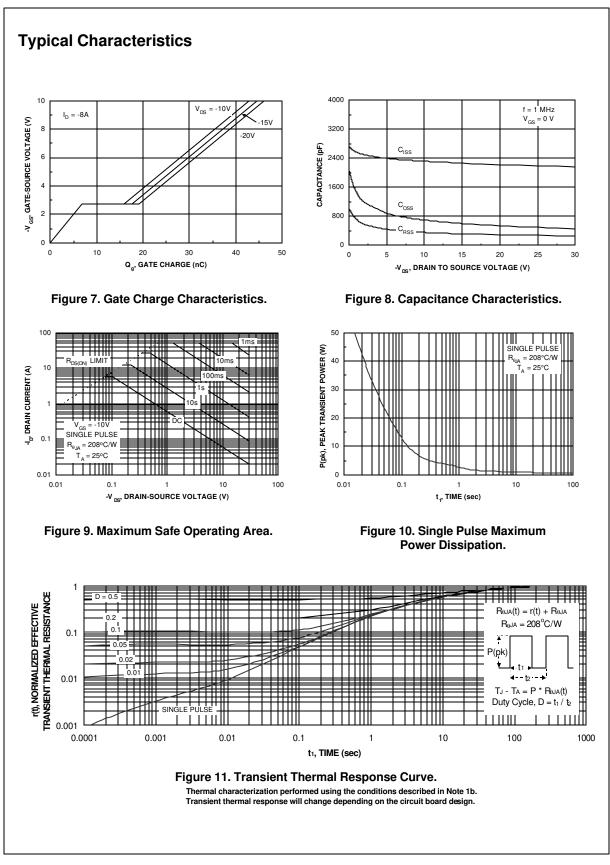
a) $\mathsf{R}_{\theta JA}$ is 96 °C/W (steady state) when mounted on a 1 inch² copper pad on FR-4.

b) ${\rm R}_{\rm 6JA}$ is 208 °C/W (steady state) when mounted on a minimum copper pad on FR-4.

2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty Cycle < 2.0%

FDW256P Rev C1(W)





FDW256P Rev C1(W)



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